

Taiwan Semiconductor

# 4A, 600V - 1000V Standard Bridge Rectifier

### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### **APPLICATIONS**

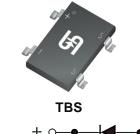
- Switching mode power supply (SMPS)
- Adapters
- Lighting application

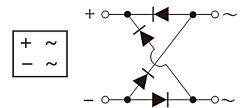
### **MECHANICAL DATA**

- Case: TBS
- Molding compound meets UL 94V-0 flammability rating
- Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1 whisker test
- Polarity: As marked
- Weight: 0.220g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	4	Α	
$V_{RRM}$	600 - 1000	V	
I <sub>FSM</sub>	110	Α	
$T_{JMAX}$	150	°C	
Package	TBS		
Configuration	Quad		

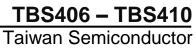






ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		SYMBOL	TBS406	TBS408	TBS410	UNIT
Marking code on the device			TBS406	TBS408	TBS410	
Repetitive peak reverse voltage		$V_{RRM}$	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	420	560	700	V
Forward current		I <sub>F</sub>	4		Α	
Surge peak forward current single half	t = 8.3ms		110		Α	
sine-wave superimposed on rated load	t = 1.0ms	I <sub>FSM</sub>	340		Α	
Rating for fusing (t<8.3ms)		l <sup>2</sup> t	50.21		A <sup>2</sup> s	
Junction temperature		TJ	-55 to +150		°C	
Storage temperature		T <sub>STG</sub>	-55 to +150		°C	

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	R <sub>ÐJL</sub>	13	°C/W	
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	50	°C/W	
Junction-to-case thermal resistance	R <sub>eJC</sub>	13	°C/W	

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	$I_F = 2A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.89	-	V
	I <sub>F</sub> = 4A, T <sub>J</sub> = 25°C		0.95	1.00	V
	I <sub>F</sub> = 2A, T <sub>J</sub> = 125°C		0.78	-	V
	I <sub>F</sub> = 4A, T <sub>J</sub> = 125°C		0.84	0.96	V
	T <sub>J</sub> = 25°C		-	2	μΑ
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	200	μΑ
Junction capacitance per diode	$1MHz, V_R = 4.0V$	C <sub>J</sub>	38	-	pF

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING	
TBS4x	TBS	1,800 / Tape & Reel	

### Notes:

1. "x" defines voltage from 600V(TBS406) to 1000V(TBS410)

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### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

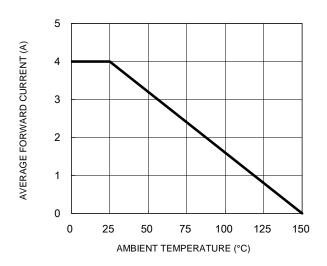


Fig.3 Typical Reverse Characteristics

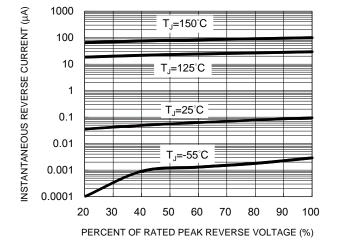
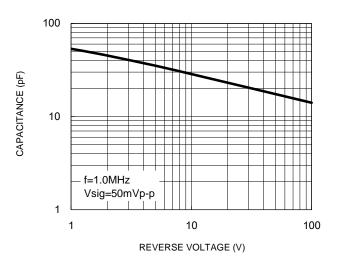
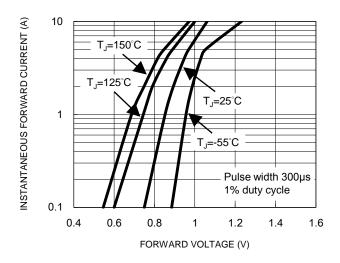


Fig.2 Typical Junction Capacitance



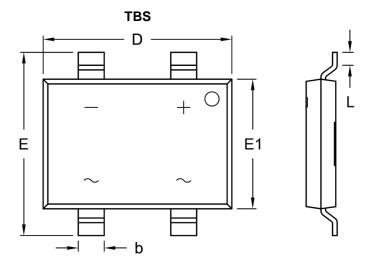
**Fig.4 Typical Forward Characteristics** 



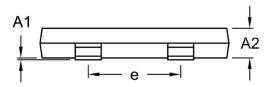
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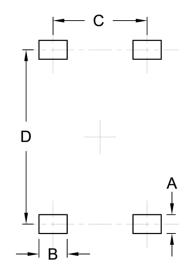
# **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit (mm)		Unit (	(inch)
Dilvi.	Min.	Max.	Min.	Max.
A1	0.00	0.15	0.000	0.006
A2	1.40	1.80	0.055	0.071
b	1.30	1.50	0.051	0.059
D	10.00	10.40	0.394	0.409
E	9.70	10.10	0.382	0.398
E1	6.80	7.20	0.268	0.283
е	4.90	5.10	0.193	0.201
L	0.50	1.10	0.020	0.043



# **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	1.00	0.039
В	1.50	0.059
С	5.00	0.197
D	9.25	0.364

# **MARKING DIAGRAM**



= Marking Code P/N ΥW = Date Code F = Factory Code



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